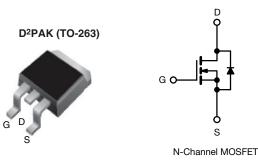
## SiHB11N80E

**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.38		
Q <sub>g</sub> max. (nC)	88			
Q <sub>gs</sub> (nC)	9			
Q <sub>gd</sub> (nC)	16			
Configuration	Single			

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION			
Package	D <sup>2</sup> PAK (TO-263)		
Lead (Pb)-free and halogen-free	SiHB11N80E-GE3		

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	800	V	
Gate-source voltage			V <sub>GS</sub>	± 30	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	12		
	VGS at TO V	T <sub>C</sub> = 100 °C		8	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	32		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	226	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		70		)///	
Reverse diode dV/dt <sup>d</sup>			dV/dt	4.3	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.0 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.7	C/W		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	800	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		1.1	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		-	4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$		-	-	± 100	nA
		N N	$I_{\rm GS} = \pm 30  \rm V$	-	-	± 1	μA
Zana anto colta co clusia comunit		V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	V <sub>DS</sub> = 640 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 5.5 A	-	0.38	0.44	Ω
Forward transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 5.5 A		-	4.5	-	S
Dynamic		•		•	•	•	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1670	-	pF
Output capacitance	C <sub>oss</sub>			-	68	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	9	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	- V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	43	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	212	-	
Total gate charge	Qg			-	44	88	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 5.5 A, V <sub>DS</sub> = 480 V		-	9	-	nC
Gate-drain charge	Q <sub>gd</sub>				16	-	
Turn-on delay time	t <sub>d(on)</sub>			-	18	36	
Rise time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 480 \; \text{V}, \; I_{\text{D}} = 5.5 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{\text{g}} = 9.1 \; \Omega \end{array}$		-	15	30	ns -
Turn-off delay time	t <sub>d(off)</sub>			-	55	110	
Fall time	t <sub>f</sub>			-	18	36	
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.9	1.8	Ω
Drain-Source Body Diode Characteristic	s	•		•		•	•
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	- A
Pulsed diode forward current	I <sub>SM</sub>			-	-	32	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 5.5 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	345	690	ns
Reverse recovery charge	Q <sub>rr</sub>			-	4.2	8.4	μC
Reverse recovery current	I <sub>RRM</sub>			-	21	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

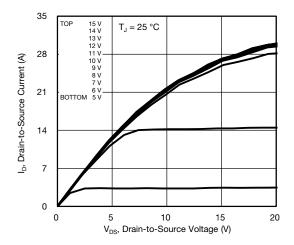
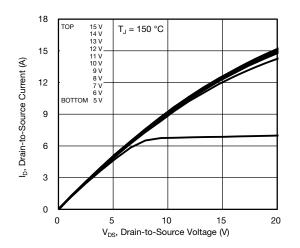
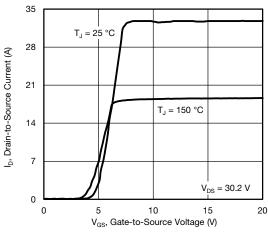


Fig. 1 - Typical Output Characteristics









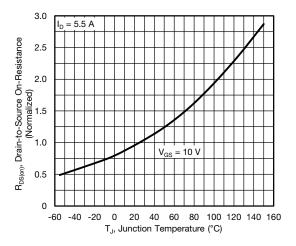


Fig. 4 - Normalized On-Resistance vs. Temperature

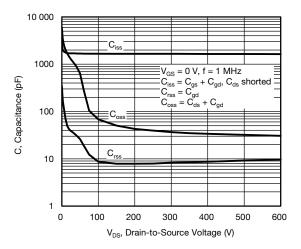


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

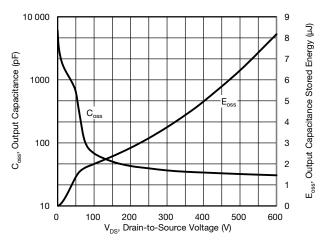


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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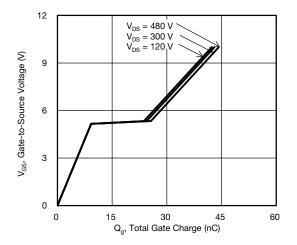


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

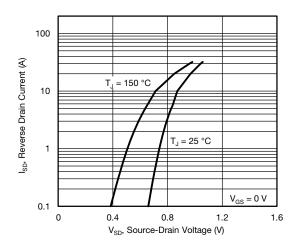


Fig. 8 - Typical Source-Drain Diode Forward Voltage

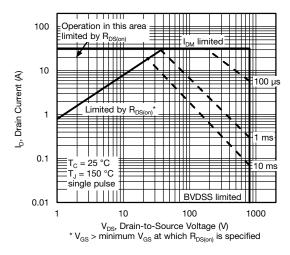


Fig. 9 - Maximum Safe Operating Area

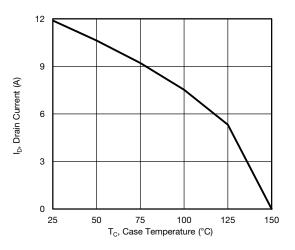


Fig. 10 - Maximum Drain Current vs. Case Temperature

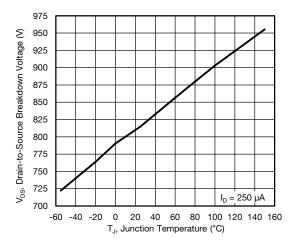
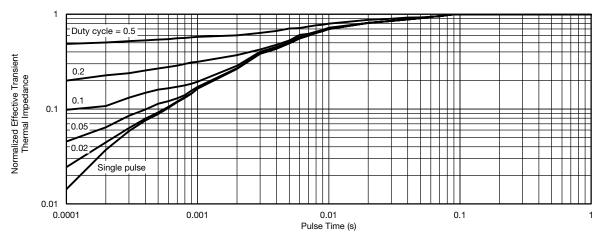


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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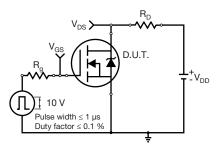


Fig. 13 - Switching Time Test Circuit

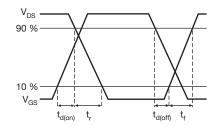


Fig. 14 - Switching Time Waveforms

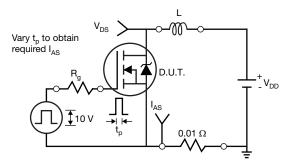


Fig. 15 - Unclamped Inductive Test Circuit

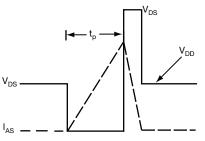


Fig. 16 - Unclamped Inductive Waveforms

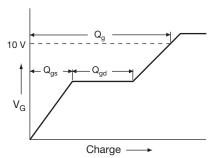


Fig. 17 - Basic Gate Charge Waveform

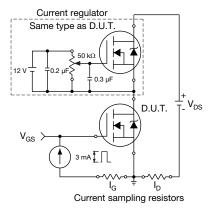


Fig. 18 - Gate Charge Test Circuit

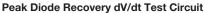
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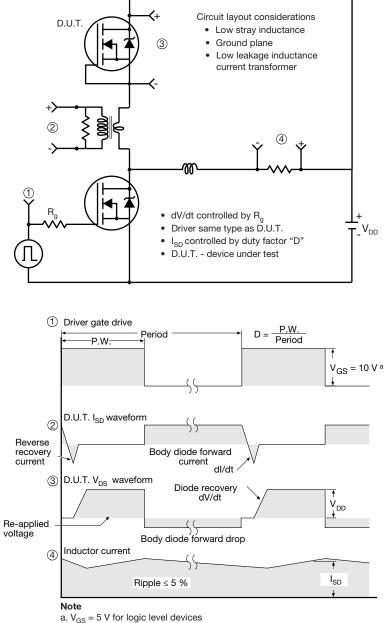


Fig. 19 - For N-Channel

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